

1.5A, 200V - 600V Super Fast Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- Freewheeling application

MECHANICAL DATA

• Case: SOD-123W

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 2 whisker test

• Polarity: Indicated by cathode band

• Weight: 0.016g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	1.5	Α	
V_{RRM}	200 - 600	V	
I _{FSM}	40	Α	
T _{J MAX}	150	°C	
Package	SOD-123W		
Configuration	Single die		









SOD-123W



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	ES15DLW	ES15GLW	ES15JLW	UNIT
Marking code on the device		ES15D	ES15G	ES15J	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	V
Forward current	I _F	1.5		Α	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	40		А	
Junction temperature	T _J	- 55 to +150		°C	
Storage temperature	T _{STG}	- 55 to +150		°C	



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R _{OJL}	26	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	76	°C/W
Junction-to-case thermal resistance	R _{eJC}	27	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
		$I_F = 0.75A, T_J = 25^{\circ}C$		0.80	-	V
	E04EDLW	I _F = 1.50A, T _J = 25°C		0.85	0.95	V
	ES15DLW	I _F = 0.75A, T _J = 125°C		0.66	-	V
		I _F = 1.50A, T _J = 125°C		0.73	0.80	V
		$I_F = 0.75A, T_J = 25^{\circ}C$		0.87	-	V
5 (1)	E04501 W	I _F = 1.50A, T _J = 25°C		0.95	1.30	V
Forward voltage ⁽¹⁾	ES15GLW	I _F = 0.75A, T _J = 125°C	V _F	0.72	-	V
		I _F = 1.50A, T _J = 125°C		0.80	1.05	V
		I _F = 0.75A, T _J = 25°C		1.06	-	V
	E045 II W	I _F = 1.50A, T _J = 25°C		1.18	1.70	V
	ES15JLW	$I_F = 0.75A, T_J = 125^{\circ}C$		0.84	-	V
		I _F = 1.50A, T _J = 125°C		0.97	1.30	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	· I _R	-	1	μΑ
		T _J = 125°C		-	150	μΑ
	ES15DLW		C _J	24	-	pF
Junction capacitance	ES15GLW	1MHz, $V_R = 4.0V$		21	-	pF
	ES15JLW			20	-	pF
Reverse recovery time		$I_F = 0.5A$, $I_R = 1.0A$ $I_{rr} = 0.25A$	t _{rr}	-	35	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
ES15xLW	SOD-123W	10,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 200V(ES15DLW) to 600V(ES15JLW)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

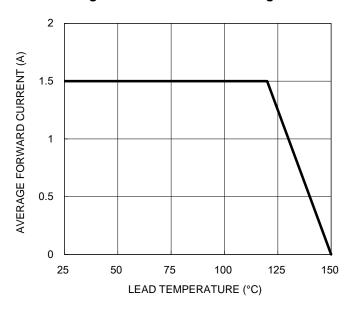


Fig.2 Typical Junction Capacitance

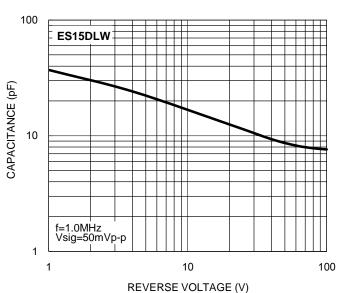


Fig.3 Typical Reverse Characteristics

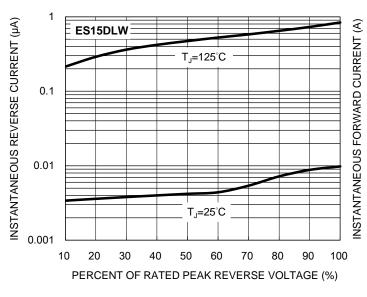


Fig.4 Typical Forward Characteristics

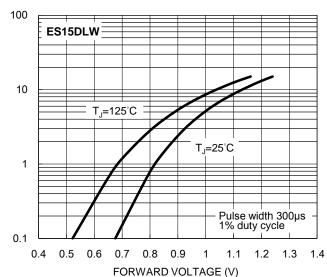


Fig.6 Typical Reverse Characteristics



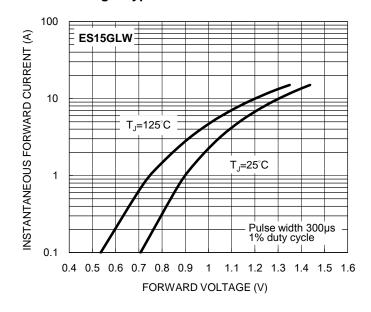
CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.5 Typical Junction Capacitance

100 10 INSTANTANEOUS REVERSE CURRENT (µA) ES15GLW ES15GLW T_J=125°C 1 CAPACITANCE (pF) 0.1 10 0.01 T_{.J}=25°C f=1.0MHz Vsig=50mVp-p 0.001 1 20 30 40 50 60 70 80 100 10 100 PERCENT OF RATED PEAK REVERSE VOLTAGE (%) REVERSE VOLTAGE (V)

Fig.7 Typical Forward Characteristics





CHARACTERISTICS CURVES

Fig.8 Typical Junction Capacitance

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

1

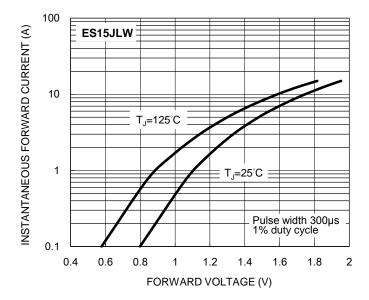
100 10 INSTANTANEOUS REVERSE CURRENT (µA) ES15JLW ES15JLW T₁=125°C 10 0.1

100

Fig.10 Typical Forward Characteristics

10

REVERSE VOLTAGE (V)



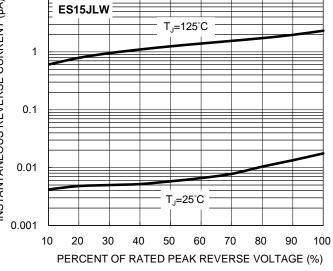
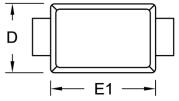


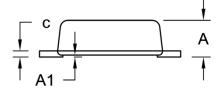
Fig.9 Typical Reverse Characteristics

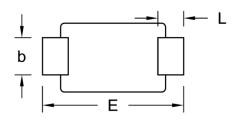


PACKAGE OUTLINE DIMENSIONS

SOD-123W

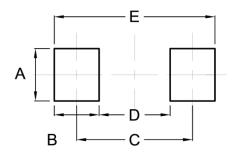






DIM.	Unit (mm)		Unit ((inch)	
DIIVI.	Min.	Max.	Min.	Max.	
Α	0.90	1.02	0.035	0.040	
A1	0.00	0.10	0.000	0.004	
b	0.90	1.05	0.035	0.041	
С	0.10	0.22	0.004	0.009	
D	1.70	1.90	0.067	0.075	
E	3.60	3.80	0.142	0.150	
E1	2.60	2.90	0.102	0.114	
L	0.50	0.85	0.020	0.033	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.40	0.055
В	1.20	0.047
С	3.10	0.122
D	1.90	0.075
E	4.30	0.169

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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